



MADANAPALLE INSTITUTE OF TECHNOLOGY & SCIENCE (Deemed to be University)



Affiliated to JNTUA, Ananthapuramu & Approved by AICTE, New Delhi
NAAC Accredited with A+ Grade, NIRF India Rankings 2024 - Band: 201-300 (Engg.)
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A Report on MoU signing Ceremony between Department of Electrical & Electronics Engineering & Culine Solutions Private Limited, on 17.10.2025

**MADANAPALLE INSTITUTE OF TECHNOLOGY & SCIENCE**
DEEMED TO BE UNIVERSITY
(under section 3 of UGC Act, 1956)
Madanapalle - 517325, Annamayya Dist., Andhra Pradesh, India





Memorandum of Understanding
Between
Department of Electrical & Electronics Engineering
&
Culine Solutions Private Limited

Date : 17.10.2025
Venue : Seminar Hall -D, MITS Madanapalle



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Report Submitted by: Dr. Arul Kumar. K, Assistant Professor, Department of Electrical & Electronics Engineering.
Resource Person Details: Mr. Arun Achoora, Director, Culine Solutions Private Limited.,
Mode of Conduct: Offline
Report Received on 27.10.2025.

The Memorandum of Understanding (MoU) signing ceremony between MITS, Madanapalle, Department of Electrical & Electronics Engineering, and Culine Solutions Private Limited, Hosur, took place on 17th October 2025 (Friday) at MITS, Madanapalle.

Event Overview

The Department of Electrical & Electronics Engineering at MITS entered into a formal partnership with Culine Solutions Private Limited to promote student industrial training, internships, industrial visits, guest lectures, collaborative projects, and research activities. This MoU aims to strengthen academic-industry relations, support practical learning, and foster innovation among students and faculty members.

Dignitaries Present

The ceremony was graced by esteemed personalities:
Mr. Arun Achoora, Director, Culine Solutions Private Limited.
Dr. P. Ramanathan, Principal of MITS Madanapalle.
Dr. Dipankar Roy, Dean, School of Engineering.
Dr. A.V. Pavan Kumar, Head, Department of Electrical & Electronics Engineering.

Purpose and Benefits:

Through this MoU, both organizations expressed their commitment to collaborative engagement in multiple areas:

1. Providing students with enriched industrial exposure and experiential learning through training and visits.
2. Organizing guest lectures and technical seminars by experts from Culine Solutions Private Limited.
3. Facilitating student internships and hands-on project work under industrial mentorship.
4. Enabling faculty and student participation in joint research and development activities.

Conclusion:

The signing of this MoU marks a significant milestone in the professional development opportunities for students and aligns with MITS's vision to integrate industry with academia for overall growth.

Acknowledgement:

I would Like to thank, Dr. P. Ramanathan, Principal of MITS Madanapalle. Dr. C. Kamal Basha, Vice Principal (Administration), Dr. Dipankar Roy, Dean, School of Engineering. Dr. A.V. Pavan Kumar, Head, Department of Electrical & Electronics Engineering and also transport in charge for arrangements from Hosur to MITS, University.